







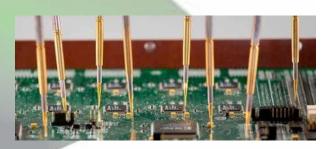


## Setting Up a Successful Test Strategy. Introduction

#### **Manufacturing Test Challenges**

- ✓ Understanding Test Resources
- ✓ Ensure Test Coverage is Maximized
- ✓ Overcome Access Issues
- ✓ Test Efficiency Test Time
- ✓ Test Development Scheduling
- ✓ Keep Test Costs Down









## What, Why, How, Who & When

What are we looking for in a test strategy?
Why do we look to establish for in a test strategy?
How to we set up a test strategy?
Who needs to designs the test strategy?
When do we look to set up for in a test strategy?





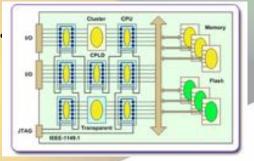
# Setting Up a Successful Test Strategy. What & Why

Test Strategy for testing the CCA multiple parts

Resources Available - @ CM or @Mfg Floor.



- Design For Test (DfT) Electrical and Mechanical.
- Understanding the design.









# Setting Up a Successful Test Strategy. What & Why

- Using the knowledge of the designer
   understanding the critical circuits
- Efficiency of testing
- To Save Time and Money









#### How do we do this?

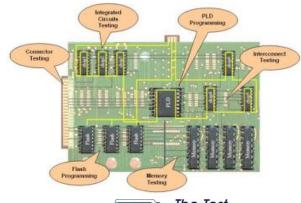
- Knowing the resources that will test or inspecting of the CCA
- Designing the test strategy early
  - Design for Test (DfT)
    - Schematics Controllability
    - Schematics Set up for tools electrical connection
      - i.e., Boundary Scan
    - Layout Access to Circuit
      - Test Points
      - Cables















#### How do we do this? (Continued)

Layout – Device locations

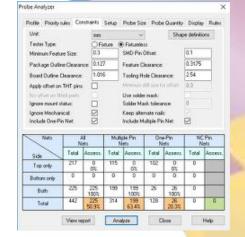
- Parts locations

i.e., Obstacles of overcome

- PCB layout

i.e., Panel or Single







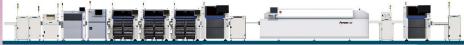




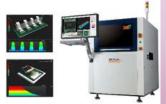


How do we do this? (Continued)

- Knowing what is needed to test or inspect your circuit assemblies



- Knowledge of manufacturing test and inspections tools.



Do we have for Electrical Test? Do we have Inspection?



Keysight 3070 ICT - inline or standard systems Mirtec 3D AOI

- IDing what manufacturing needs or what do they have available.

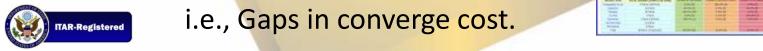
**Engineering ID needs** Contract calls out needs

 Minimize overlap and gaps i.e., Overlaps in coverage cost.





Connection, Inc.





Fixturing – Bed of Nails



Bed of Nails (ICT or Custom) – DfT Rules : Size and

Spacing.

Looking at probing the CCA.

Type of targets? Vias, Test Points, etc.





Size as small as 18 - 20 mils, but tight tolerance custom fixturing is suggested for PCBs for production. 28 - 32 mils for wider tolerances for PCBs. Remember this is for a production efforts.

Don't confuse size and spacing



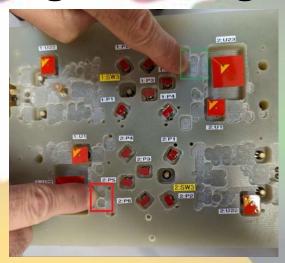
The Test Connection, Inc.

Thank you Ingun and H & W Fixture for Photos

# Setting Up a Successful Test Strategy. Test Engineering Probing Challenges

#### **Probing Challenges -**

- ✓ Components Placement tolerances
- ✓ Probing



Fixture has stack up



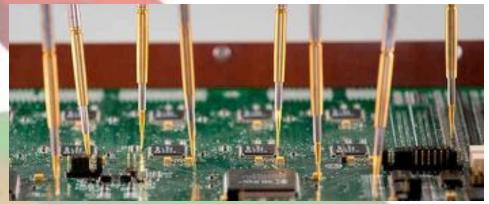
i.e. TP placement near Switches



The Test Connection, Inc.

**Electro-Mechanical Probing** or Flying Probe Testing

i.e. Even with FPT being DfT
Lenient Testing – Size or PCB
tolerances make a difference.



Size as small as 3-4 mils, but 3% tolerance is suggested for PCBs for production.

10-12 mils for wider tolerances for PCBs. Remember this is for a production efforts. Ask why?





Stake holders - collaboration with these teams are key.

**Test Engineering** – As the test & inspection development and sustaining effort of the circuit assembly.

**Project Engineer/Manager** – Setting up budgets and scheduling deployment and who will inherit the tests of the assembly.

Design Engineering – Putting in the testability and inspectability into the circuit assembly.





Stake holders - collaboration with these teams are key.

**Process Engineering** – How does test and inspection fit into circuit assembly process.

Manufacturing Engineering – Inherited the tests and inspection of the assembly.

Anyone else????

What about **Vendors and Partners?** Knowing what is being quoted is key to execution of the vision.



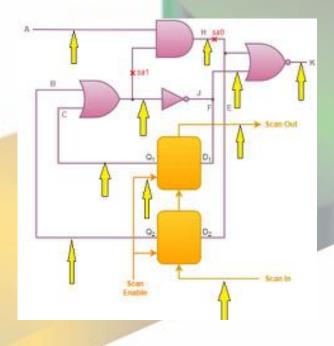


Good Old Days.

DfT would just ask for Access to all or most of

the pins on a circuit

Mainly for ICT 3070 or GR228x systems



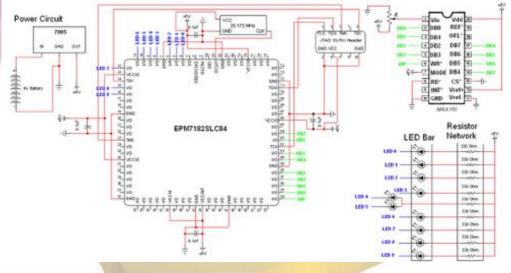




At the Start of the design.....

When laying out the schematics, we should be thinking about controllability. i.e. Think about what pins are key to

control the CCA.



As you select devices for schematics and BOM, are there any automated testing we can use. i.e. Boundary Scan, BIST, etc.



Access to the circuit assembly has grown in complexity.

Access needs to be measured by test methodology, production cost, volume of production and test development cost.

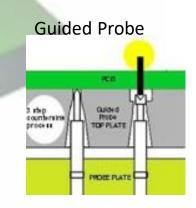
QA Tech., Ingun, TCI, IDI and Cohu probes can touch anything well, BUT.....As we get more specialize costs increase.

Circuit Check, Arcadia, QxQ, RNS, and TTCI can fixture anything to touch a target (with in guidelines) As we get more specialize costs increase.



Thank you, Arcadia Test, for the use of this fixturing image Thank you, QA Technologies, for the use of this photo image







Conclusion

Multiple Stake holders – Design, Program/Project Team, Production Team

Starts Earlier is Best – DfT with Design Starts



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Multiple Test and Inspection Solutions (tools) – Knowing is in the Arsenal







Any Questions?

Thank you for your interest.

My contact information.

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